ESD Protected

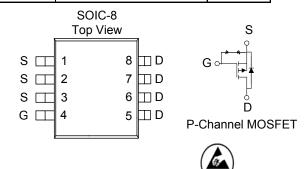
P-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

•	Low r _{DS(on)} provides higher efficiency and
	extends battery life

- Low thermal impedance copper leadframe SOIC-8 saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY				
V _{DS} (V)	$r_{\mathrm{DS(on)}} m(\Omega)$	I _D (A)		
-30	$19 @ V_{GS} = -10V$	-9.5		
-30	$30 @ V_{GS} = -4.5V$	-7.5		



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C UNLESS OTHERWISE NOTED)					
Parameter			Maximum	Units	
Drain-Source Voltage			-30	V	
Gate-Source Voltage			±25	V	
Continuous Drain Current ^a	$T_A=25^{\circ}C$.T.,	-9.5	_	
Continuous Drain Current	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	1D	-8.3	A	
Pulsed Drain Current ^b		I_{DM}	±50		
Continuous Source Current (Diode Conduction) ^a		I_S	-2.1	Α	
D a	$T_A=25^{\circ}C$	D_	3.1	W	
Power Dissipation ^a	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	Гр	2.6		
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Maximum	Units		
Maximum Junction-to-Case ^a	t <= 5 sec	$R_{ heta JC}$	25	°C/W		
Maximum Junction-to-Ambient ^a	t <= 10 sec	$R_{ heta JA}$	50	°C/W		

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Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

Davama 4a u	Cymah - 1		Limits			TT	
Parameter	Symbol	Symbol Test Conditions		Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \text{ uA}$	-30			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \text{ uA}$	-1	-1.6	-3	V	
Gate-Body Leakage	IGSS	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			±200	nA	
Zara Cata Valta da Drain Current	I- aa	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$	-1		л. А		
Zero Gate Voltage Drain Current	Idss	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			-5	uA	
On-State Drain Current ^A	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-50			A	
		$V_{GS} = -10 \text{ V}, I_D = -9.5 \text{ A}$		16	19		
Drain-Source On-Resistance ^A	r _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -7.5 \text{ A}$		26	30	mΩ	
		$V_{GS} = -10 \text{ V}, I_D = -9.5 \text{ A}, T_J = 55^{\circ} \text{C}$		20	29]	
Forward Tranconductance ^A	gs	$V_{DS} = -15 \text{ V}, I_D = -9.5 \text{ A}$		31		S	
Diode Forward Voltage	V _{SD}	$I_S = -2.1 \text{ A}, V_{GS} = 0 \text{ V}$		-0.7	-1.2	V	
Dynamic ^b							
Total Gate Charge	Qg	V 15 V V 45 V		12.8	20		
Gate-Source Charge	Qgs	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V},$ $I_{D} = -9.5 \text{ A}$		4.5		nC	
Gate-Drain Charge	Q_{gd}			5			
Switching							
Turn-On Delay Time	t _{d(on)}			15	26		
Rise Time	tr	V_{DD} = -15 V, R_L = 15 Ω , I_D = -1 A,		12	21	, C	
Turn-Off Delay Time	t _{d(off)}	$V_{GEN} = -10 \text{ V}, R_G = 6\Omega$		62	108	nS	
Fall-Time	tf			46	71		

Notes

- a. Pulse test: $PW \le 300us duty cycle \le 2\%$.
- b. Guaranteed by design, not subject to production testing.

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Typical Electrical Characteristics (P-Channel)

0.04

0.032

0.024

0.016

0.008

0

RDS(ON) Resistance (Ω)

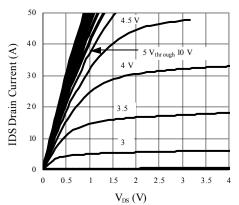


Figure 1. On-Region Characteristics

1.6

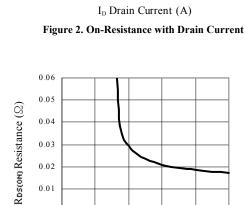
1.2

-50

Normalized R_{DS}(on)

 $V_{GS} = 10V$

 $I_{D} = 9.5A$



T_J Juncation Temperature (°C)

Figure 3. On-Resistance Variation with Temperature

25 50 75 100 125

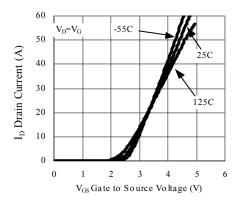
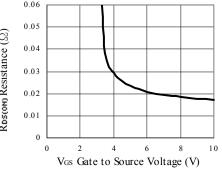


Figure 5. Transfer Characteristics



 $V_{GS}=4.5V$

 $V_{GS}=10V$

30

Figure 4. On-Resistance Variation with Gate to Source Voltage

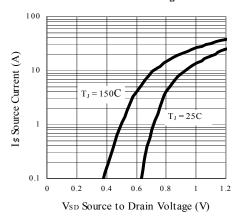


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Typical Electrical Characteristics (P-Channel)

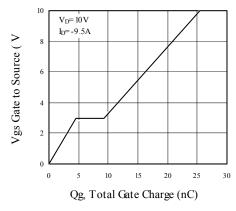


Figure 7. Gate Charge Characteristics

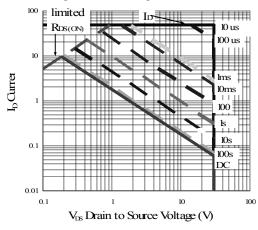


Figure 9. Maximum Safe Operating Area

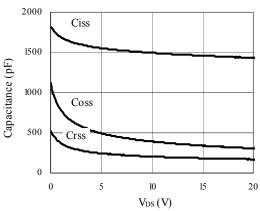


Figure & Canacitance Characteristics

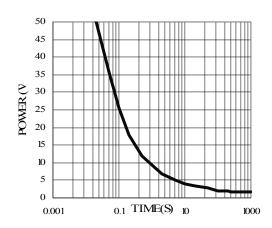
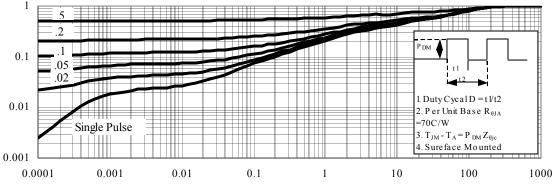


Figure 10. Single Pulse Maximum Power Dissipation



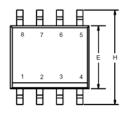


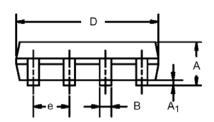
Square Wave Pulse Duration (S)

Figure 11. Transient Thermal Response Curve

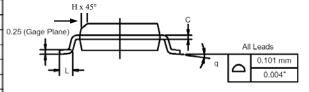
Package Information

SO-8: 8LEAD





	MILLIN	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	



Ordering information

AM4835EP-T1-XX

- A: Analog Power

- M: MOSFET

– 4835: Part number

– E: ESD Protected

– P: P-Channel

- T1: Tape & reel

– XX: Blank: Standard

PF: Leadfree